

AM26LS29

Quad Three-State Single Ended RS-423 Line Driver

The AM26LS29 is a quad single ended line driver, designed for digital data transmission. The AM26LS29 meets all the requirements of EIA Standard RS-423 and Federal STD 1030. It features four buffered outputs with high source and sink current, and output short circuit protection.

A slew rate control pin allows the use of an external capacitor to control slew rate for suppression of near end cross talk to receivers in the cable. The AM26LS29 is constructed using advanced lowpower Schottky processing.

Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All re-creations are done with the approval of the Original Component Manufacturer. (OCM)

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceeds the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-35835
 - Class Q Military
 - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)
 - Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OCM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

FOR REFERENCE ONLY



Am26LS29

Quad Three-State Single Ended RS-423 Line Driver

DISTINCTIVE CHARACTERISTICS

- Four single ended line drivers in one package for maximum package density
- Output short-circuit protection
- Individual rise time control for each output
- High capacitive load drive capability
- Low I_{CC} and I_{EE} power consumption (26mW/driver typ.)
- Meets all requirements of RS-423
- Three-state outputs for bus oriented systems
- Outputs do not clamp line with power off. Outputs are in high-impedance state over entire transmission line voltage range of RS-423
- Low current PNP inputs compatible with TTL, MOS and CMOS
- Available in military and commercial temperature range
- Advanced low power Schottky processing

GENERAL DESCRIPTION

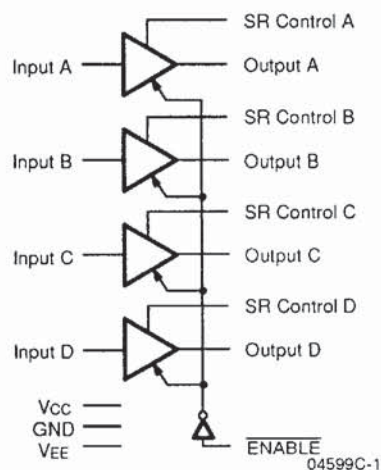
The Am26LS29 is a quad single ended line driver, designed for digital data transmission. The Am26LS29 meets all the requirements of EIA Standard RS-423 and Federal STD 1030. It features four buffered outputs with high source and sink current, and output short circuit protection.

A slew rate control pin allows the use of an external capacitor to control slew rate for suppression of near end cross talk to receivers in the cable.

The Am26LS29 has three-state outputs for bus oriented systems. The outputs in the high-impedance state will not clamp the line over the transmission line voltage of RS-423. A typical full duplex system would use the Am26LS29 line driver and up to twelve Am26LS32 line receivers or an Am26LS32 line receiver and up to thirty-two Am26LS29 line drivers with only one enabled at a time and all others in the three-state mode.

The Am26LS29 is constructed using advanced low-power Schottky processing.

BLOCK DIAGRAM





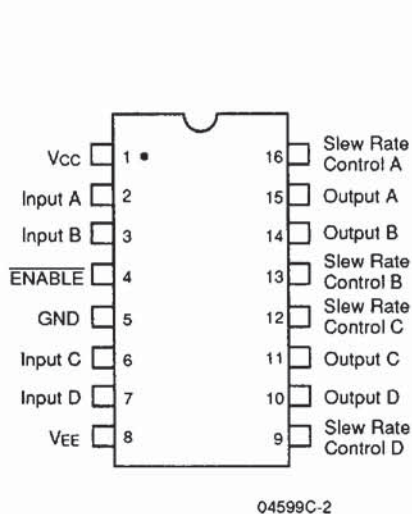
RELATED PRODUCTS

Part Number	Description
26LS30	Dual Differential RS-422 Party Line/Quad Single Ended RS-423 Line Driver
26LS32	Quad Differential Line Receiver
26LS33	Quad Differential Line Receiver

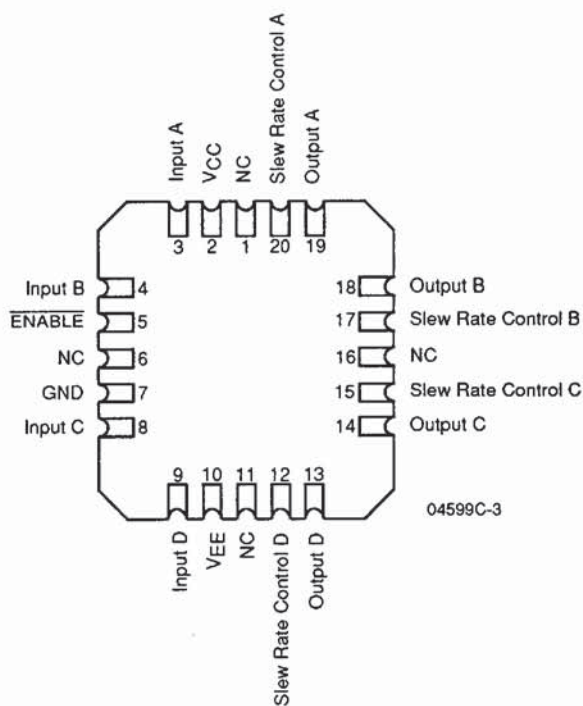
CONNECTION DIAGRAMS

Top View

DIP



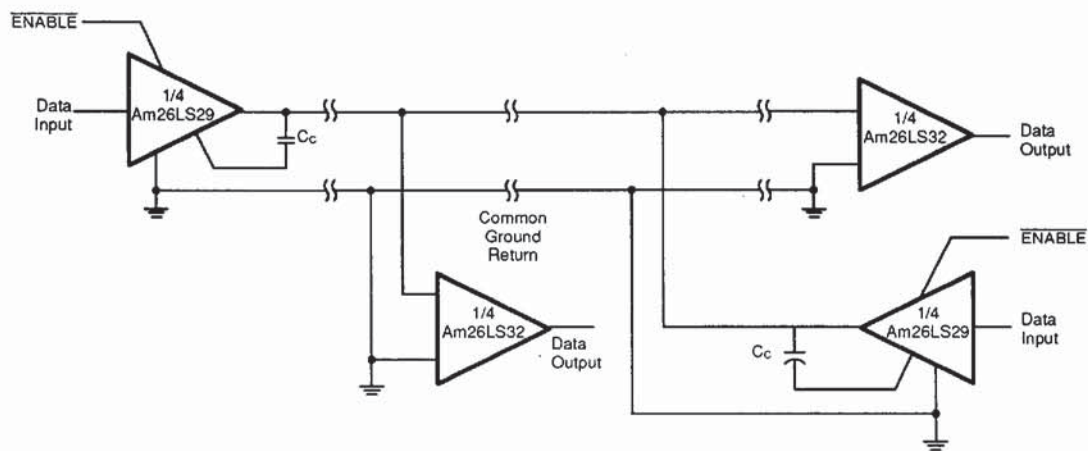
PLCC



Note:

Pin 1 is marked for orientation

TYPICAL APPLICATION



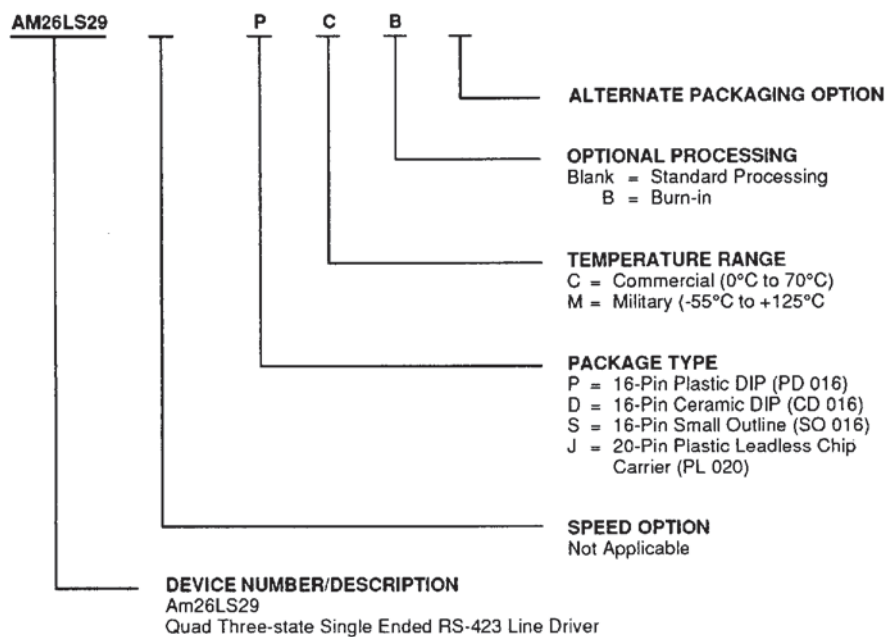
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ORDERING INFORMATION

Standard Products

AMD products are available in several packages and operating ranges. The ordering number (Valid Combination) is formed by a combination of:



Valid Combinations	
AM26LS29	PC, PCB, DC, DCB, SC, JC, DMB

Valid Combinations

The Valid Combinations lists configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations and to check on newly released combinations.

ABSOLUTE MAXIMUM RATINGS

Storage Temperature Range -65°C to +165°C

Supply Voltage:

V₊ 7.0 VV₋ -7.0 V

Power Dissipation 165 mW

Input Voltage -1.5 V to +15 V

Enable Voltage ±15 V

Output Sink Current 300°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.

OPERATING RANGES**Commercial (C) Devices**Temperature (T_A) 0°C to +70°CSupply Voltage (V_{CC}) +4.75 V to +5.25 V
(V_{EE}) -4.75 V to -5.25 V**Military (M) Devices**Temperature (T_A) -55 to +125°CSupply Voltage (V_{CC}) +4.75 V to +5.5 V
(V_{EE}) -4.75 V to -5.5 V

Operating ranges define those limits between which the functionality of the device is guaranteed.

DC CHARACTERISTICS over COMMERCIAL operating range unless otherwise specified

Parameter Symbol	Parameter Description	Test Conditions	Min	Typ (Note 1)	Max	Unit
$\frac{V_O}{\overline{V_O}}$	Output Voltage	V _{CC} = V _{EE} = Min R _L = ∞ (Note 3)	V _{IN} = 2.4 V V _{IN} = 0.4 V	4.0 -4.0	4.4 -4.4	V V
$\frac{V_T}{\overline{V_T}}$	Output Voltage (Note 4)	V _{CC} = V _{EE} = Min R _L = 450 Ω	V _{IN} = 2.4 V V _{IN} = 0.4 V	3.6 -3.6	4.1 -4.1	V V
V _T - $\overline{V_T}$	Output Unbalance (Note 4)	V _{CC} = V _{EE} , R _L = 450 Ω		0.02	0.4	V
I _{X+}	Output Leakage Power Off	V _{CC} = V _{EE} = 0V	V _O = 10 V		100	μA
I _{X-}			V _O = -10 V		-100	μA
I _{S+}	Output Short Circuit Current (Note 6)	V _{CC} = V _{EE} = Max V _O = 0 V	V _{IN} = 2.4 V	-20	-80	mA
I _{S-}			V _{IN} = 0.4 V	20	80	mA
I _{CC}	Positive Supply Current	V _{IN} = 0.4 V, R _L = ∞, V _{CC} = V _{EE} = Max		18	30	mA
I _{EE}	Negative Supply Current	V _{IN} = 0.4 V, R _L = ∞, V _{CC} = V _{EE} = Max		-10	-22	mA
I _O	Off State (High Impedance)	V _{CC} = Max	V _O = 10 V		100	μA
	Output Current	V _{CC} = V _{EE} = Max	V _O = -10 V		-100	μA
V _{IH}	High Level Input Voltage	(Note 7)	2.0			V
V _{IL}	Low Level Input Voltage	(Note 7)			0.8	V
I _{IH}	High Level Input Current	V _{IN} = 2.4 V, V _{CC} = V _{EE} = Max			40	μA
		V _{IN} ≤ 15 V, V _{CC} = 5.5 V, V _{EE} = -5.0 (Note 5)			100	μA
I _{IL}	Low Level Input Current	V _{IN} = 0.4 V, V _{CC} = V _{EE} = Max		-30	-200	μA
V _I	Input Clamp Voltage	I _{IN} = -12mA, V _{CC} = Min, V _{EE} = Max			-1.5	V

Notes:

1. Typical limits are at V_{CC} = 5.0 V, V_{EE} = -5.0 V, 25°C ambient and maximum loading.
2. Symbols and definitions correspond to EIA RS-423 where applicable.
3. Output voltage is +3.9 V minimum and -3.9 V minimum at -55°C.
4. This parameter is tested by forcing an equivalent current.
5. V_{EE} = -5.0 V due to tester limitation.
6. Not more than one output should be shorted at a time. Duration of short circuit test should not exceed one second.
7. Input thresholds are tested during DC tests and may be done in combination with testing of other DC parameters.



SWITCHING CHARACTERISTICS ($T_A = +25^{\circ}\text{C}$, $V_{CC} = 5.0\text{V}$, $V_{EE} = -5.0\text{V}$)

Parameter Symbol	Parameter Description	Test Conditions	Min	Typ	Max	Unit
t_r	Rise Time	$R_L = 450\ \Omega$, $C_L = 500\ \text{pF}$, Fig. 1		3.0		μs
		$C_c = 50\ \text{pF}$		120	300	ns
t_f	Fall Time	$R_L = 450\ \Omega$, $C_L = 500\ \text{pF}$, Fig. 1		3.0		μs
		$C_c = 50\ \text{pF}$		120	300	ns
t_{pdh}	Output Propagation Delay	$R_L = 450\ \Omega$, $C_L = 500\ \text{pF}$, $C_c = 0\ \text{pF}$		180	300	ns
t_{pdl}	Output Propagation Delay	$R_L = 450\ \Omega$, $C_L = 500\ \text{pF}$, $C_c = 0\ \text{pF}$		180	300	ns
t_{LZ}	Output Enable to Output	$R_L = 100\ \Omega$, $C_L = 500\ \text{pF}$, $C_c = 0\ \text{pF}$, Fig. 2		180	300	ns
t_{HZ}				200	350	
t_{ZL}		$R_L = 100\ \Omega$, $C_L = 500\ \text{pF}$, $C_c = 0\ \text{pF}$, Fig. 2		200	350	
t_{ZH}				180	300	

AC CHARACTERISTICS ($T_A = -55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, $V_{CC} = 4.75\text{V}$ to 5.5V , $V_{EE} = 4.75\text{V}$ to 5.5V)

Parameter Symbol	Parameter Description	Test Conditions	Min	Typ	Max	Unit
t_r	Rise Time	$R_L = 450\ \Omega$, $C_L = 500\ \text{pF}$, $C_c = 0\ \text{pF}$			450	μs
t_f	Fall Time	$R_L = 450\ \Omega$, $C_L = 500\ \text{pF}$, $C_c = 0\ \text{pF}$			450	μs
t_{pdh}	Output Propagation Delay	$R_L = 450\ \Omega$, $C_L = 500\ \text{pF}$, $C_c = 0\ \text{pF}$			450	ns
t_{pdl}	Output Propagation Delay	$R_L = 450\ \Omega$, $C_L = 500\ \text{pF}$, $C_c = 0\ \text{pF}$			450	ns
t_{LZ}	Output Enable to Output	$R_L = 100\ \Omega$, $C_L = 500\ \text{pF}$, $C_c = 0\ \text{pF}$			400	ns
t_{HZ}		$R_L = 100\ \Omega$, $C_L = 500\ \text{pF}$, $C_c = 0\ \text{pF}$			400	ns
t_{ZL}		$R_L = 100\ \Omega$, $C_L = 500\ \text{pF}$, $C_c = 0\ \text{pF}$			400	ns
t_{ZH}		$R_L = 100\ \Omega$, $C_L = 500\ \text{pF}$, $C_c = 0\ \text{pF}$			400	ns

SWITCHING TEST CIRCUIT

SWITCHING TEST WAVEFORM

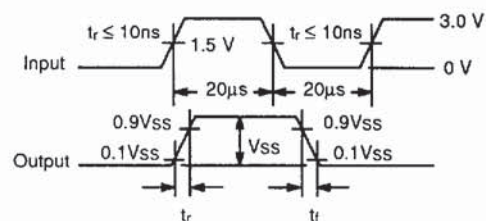
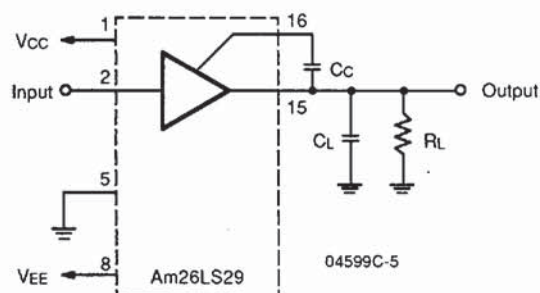


Figure 1. Rise Time Control

SWITCHING TEST CIRCUIT

SWITCHING TEST WAVEFORM

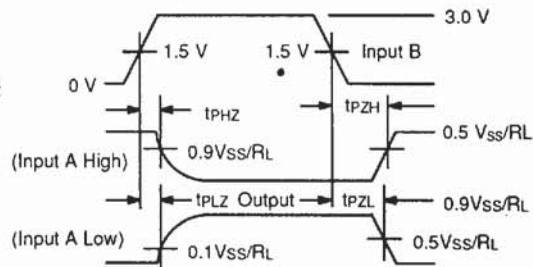
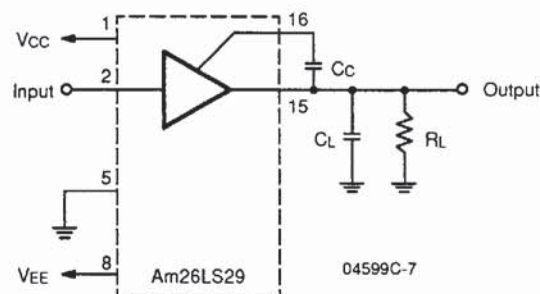
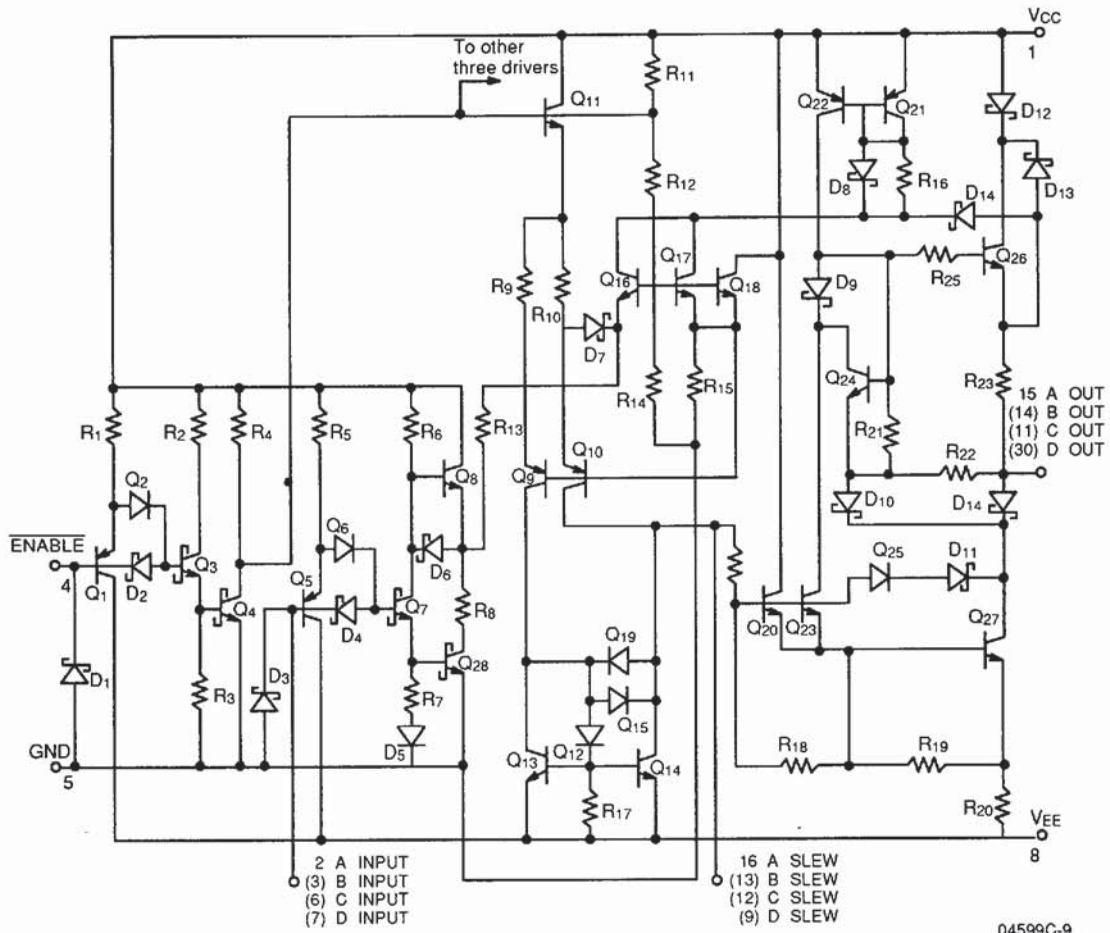
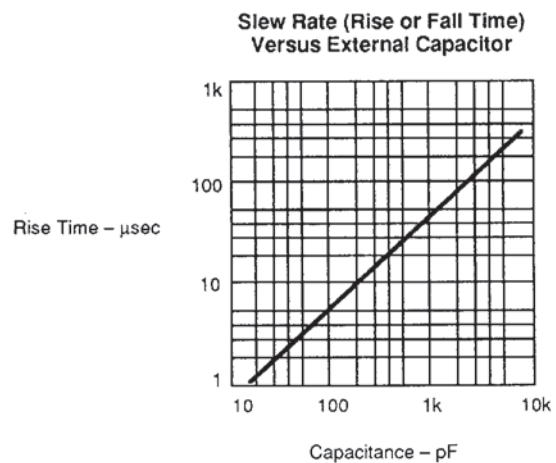


Figure 2. Three-State Delays

Am26LS29 EQUIVALENT CIRCUIT



TYPICAL PERFORMANCE CURVES



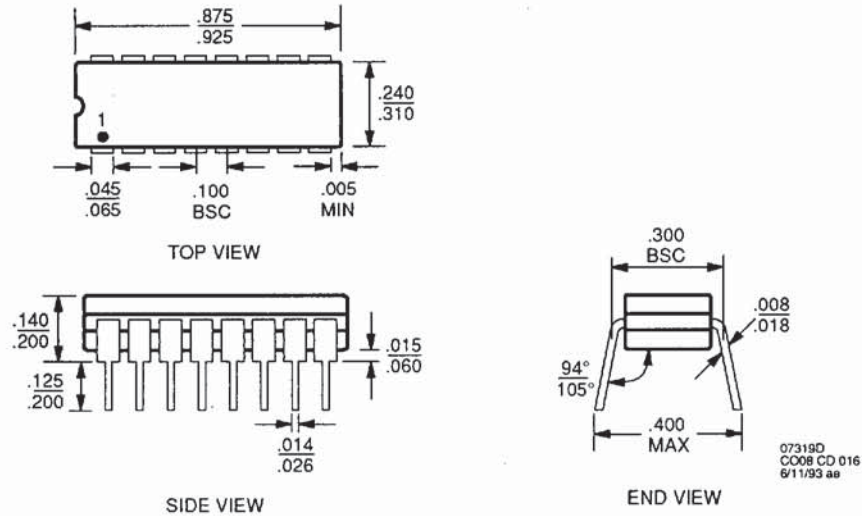
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PHYSICAL DIMENSIONS*

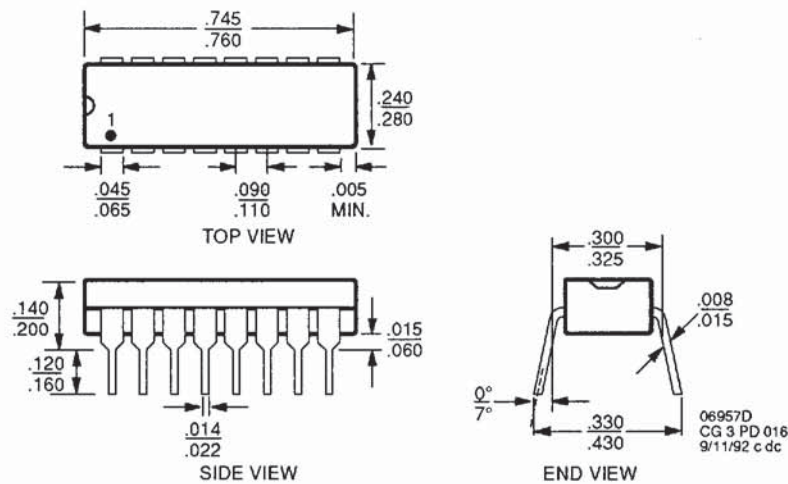
CD 016

16-Pin Ceramic DIP (measured in inches)



PD 016

16-Pin Plastic DIP (measured in inches)

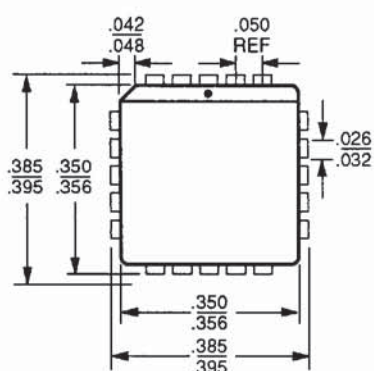


*For reference only. BSC is an ANSI standard for Basic Space Centering.

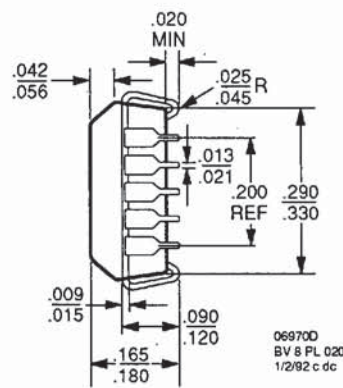
PHYSICAL DIMENSIONS

PL 020

20-Pin Plastic Leadless Chip Carrier (measured in inches)



TOP VIEW

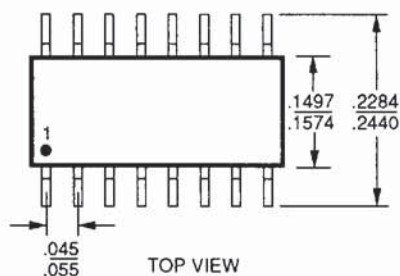


SIDE VIEW

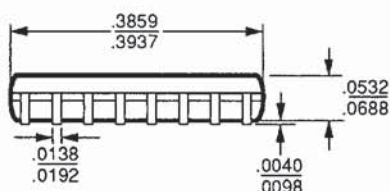
069700
BV 8 PL 020
1/2/92 c dc

SO 016

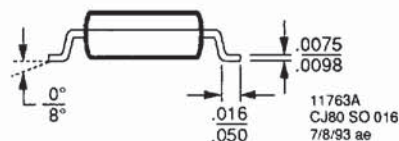
16-Pin Small Outline (measured in inches)



TOP VIEW



SIDE VIEW



END VIEW

11763A
CJ80 SO 016
7/8/93 ae

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